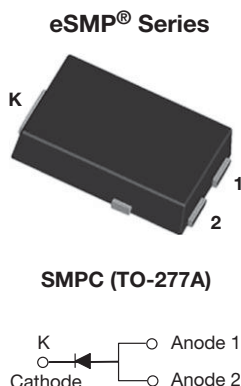
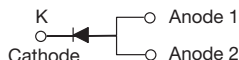


# High Current Density Surface Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.36\text{ V}$  at  $I_F = 5\text{ A}$



SMPC (TO-277A)



## DESIGN SUPPORT TOOLS

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PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	15 A
$V_{RRM}$	80 V
$I_{FSM}$	220 A
$V_F$ at $I_F = 15\text{ A}$ ( $T_A = 125\text{ °C}$ )	0.55 V
$T_J$ max.	150 °C
Package	SMPC (TO-277A)
Circuit configuration	Single

## FEATURES

- Very low profile - typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

## MECHANICAL DATA

**Case:** SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3\_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

("\_X" denotes revision code e.g. A, B,.....)

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS ( $T_A = 25\text{ °C}$ unless otherwise noted)			
PARAMETER	SYMBOL	V15P8	UNIT
Device marking code		V158	
Maximum repetitive peak reverse voltage	$V_{RRM}$	80	V
Maximum average forward rectified current (fig. 1)	$I_F^{(1)}$	15	A
	$I_F^{(2)}$	4.6	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	220	A
Voltage rate of change (rated $V_R$ )	$dV/dt$	10 000	V/ $\mu$ s
Operating junction and storage temperature range	$T_J, T_{STG}$	-40 to +150	°C

## Notes

(1) Mounted on 30 mm x 30 mm pad areas aluminum PCB

(2) Free air, mounted on recommended copper pad area

ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 5.0 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.45	-	V
	I <sub>F</sub> = 7.5 A			0.49	-	
	I <sub>F</sub> = 15 A			0.58	0.66	
	I <sub>F</sub> = 5.0 A	T <sub>A</sub> = 125 °C		0.36	-	
	I <sub>F</sub> = 7.5 A			0.42	-	
	I <sub>F</sub> = 15 A			0.55	0.63	
Reverse current	V <sub>R</sub> = 80 V	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	-	1.2	mA
		T <sub>A</sub> = 125 °C		20	50	

**Notes**

- (1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle  
(2) Pulse test: pulse width  $\leq 5\text{ ms}$

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	V15P8	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)(2)}$	75	$^{\circ}\text{C/W}$
	$R_{\theta JM}^{(3)}$	4	

**Notes**

- (1) The heat generated must be less than the thermal conductivity from junction to ambient:  $dP_D/dT_J < 1/R_{\theta JA}$   
(2) Free air mounted on recommended copper pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient  
(3) Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance  $R_{\theta JM}$  - junction to mount

<b>ORDERING INFORMATION</b> (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V15P8-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel
V15P8-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel
V15P8HM3_A/H <sup>(1)</sup>	0.10	H	1500	7" diameter plastic tape and reel
V15P8HM3_A/I <sup>(1)</sup>	0.10	I	6500	13" diameter plastic tape and reel

**Note**

- (1) AEC-Q101 qualified

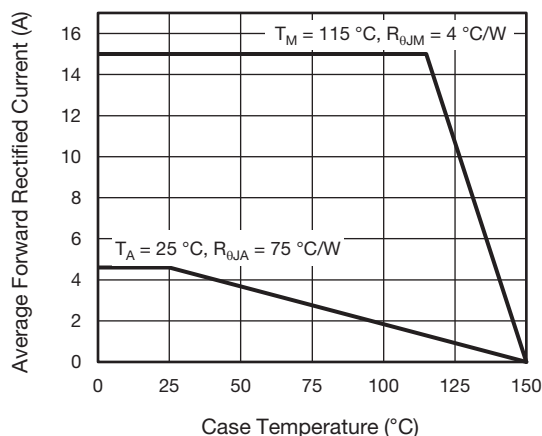
**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)


Fig. 1 - Forward Current Derating Curve

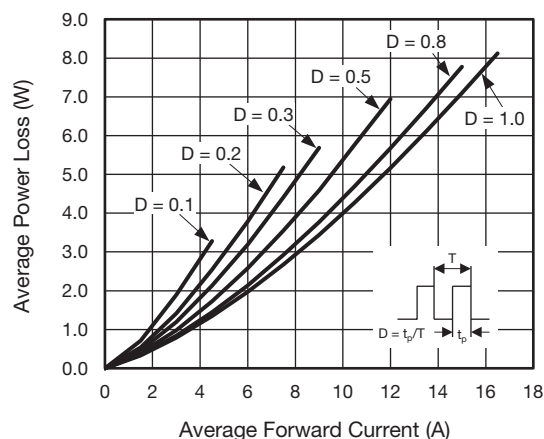


Fig. 2 - Forward Power Loss Characteristics

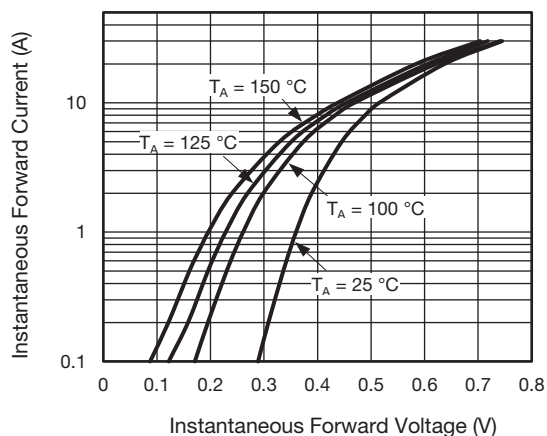


Fig. 3 - Typical Instantaneous Forward Characteristics

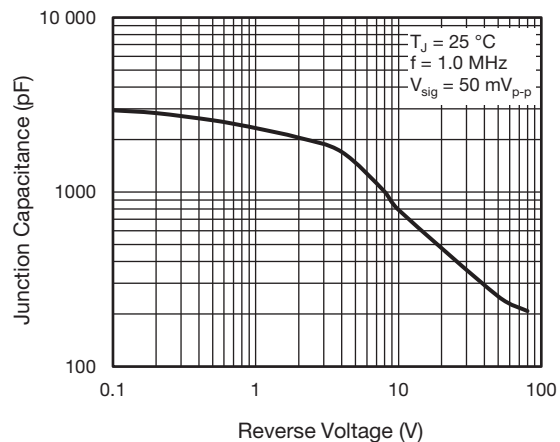


Fig. 5 - Typical Junction Capacitance

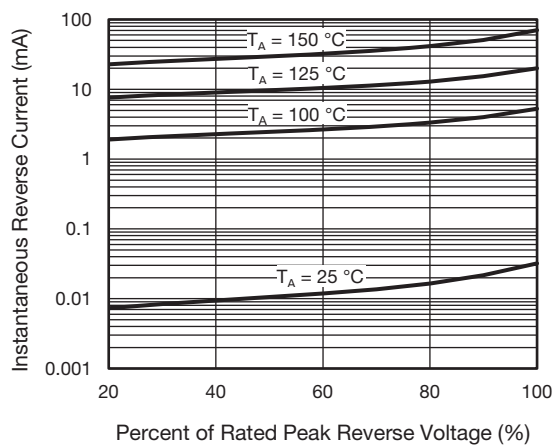


Fig. 4 - Typical Reverse Leakage Characteristics

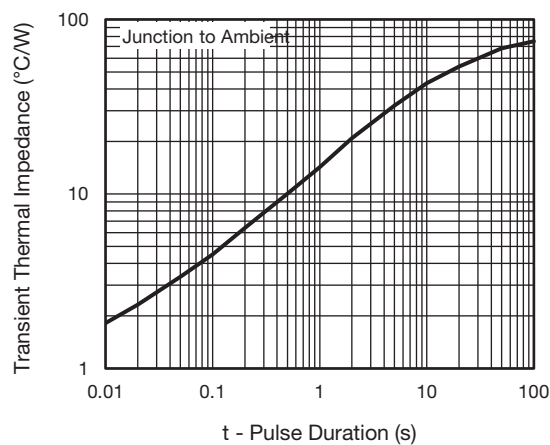
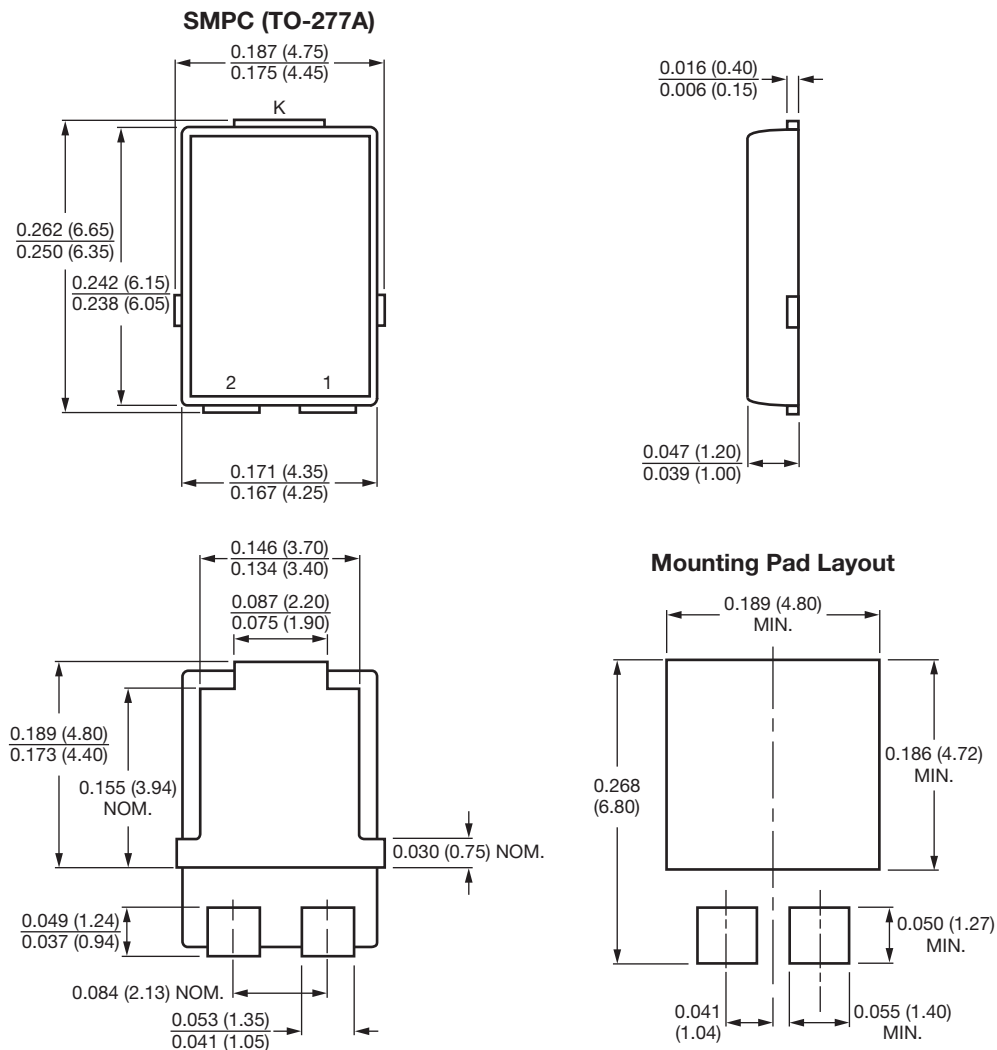


Fig. 6 - Typical Transient Thermal Impedance

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)




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